

VTC 7110-D1K

Intel® Core™ i7 Fanless In-Vehicle Computer with
Isolation GPIO, COM and OBDII



Main Features

- Build-in Intel® Core™ i7 2610UE 1.5G Hz processor
- Support two Ethernet LAN ports
- Removable 2.5" SSD tray and CFAST slot
- OBDII support of SAE J1939 or J1708
- Support two SIM card slots
- PCI-104 socket
- 9~36V wide range DC power input
- Smarter power management and low voltage protection
- Support isolation digital input/ output and analog input
- Rugged fanless design to meet MIL standard
- Support Isolation RS-232 and RS-422/485
- Wake on RTC/SMS via WWAN module

Product Overview

VTC 7110-D1K, adopting the high performance processor, Intel® Core™ i7, is a new generation of VTC series. In addition to keep the advantage of existing VTC series, it offers dual LAN ports for redundancy, two high speed interface for storage, 2.5" SATA and CFAST. The storage is easily accessible from the front side for maintenance concern. Furthermore, it offers the OBDII for heavy duty truck such as SAE J1939/ J1708 and isolation digital input, output, RS-232 and RS-422/485. With the rich features, VTC7110-D1K can satisfy your demand in vehicle applications.

Specifications

CPU

- Intel® Core™ i7 2610UE 1.5GHz

Main Chipset

- QM67

Memory

- One 204-pin DDR3 1333MHz SO-DIMM slot (up to 8GB)

Expansion

- 1 x Mini-PCIe socket (PCIe + USB) for WLAN option
- 1 x Mini-PCIe socket (USB) for WWAN option
- 1 x Bluetooth module for option
- 1 x on board uBlox NEO-6Q GPS module or optional GPS with dead reckoning

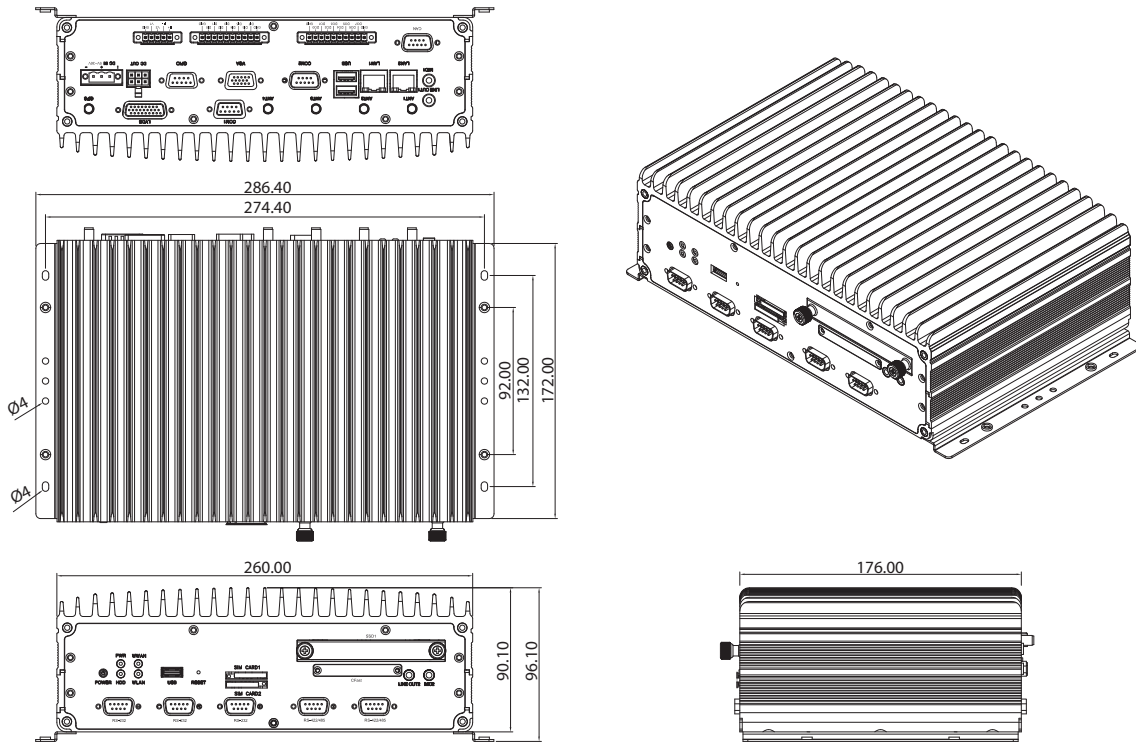
I/O Interface-Front

- 1 x Line-out, 1 x Mic-in (for WWAN CM8000 voice communication)
- 2 x SIM card socket (selectable)
- 1 x System reset button
- 1 x USB 2.0 host type A connector
- 1 x Power button
- 1 x CFAST with protection cover
- 1 x Accessible 2.5" SATA II SSD tray
- 2 x DB9 isolation RS-422/ 485, Isolation: 5K Vrms
- 3 x DB9 isolation RS-232, Isolation: 5K Vrms
- 4 x LED's for power, storage, WLAN/ WWAN and GPIO
- G sensor

I/O Interface-Rear

- 1 x 9~36VDC input with Ignition
- 1 x 12V/4A DC output, SMBus
- 1 x DB26 LVDS interface with 12V and USB2.0
- 1 x DB9 RS-232 (default) or OBDII (option)
- 1 x DB9 RS-422/ 485
- 1 x DB9 female connector for 4 x DI and 4 x DO (Digital Input)
 - Input Voltage (Internal Type): 5VDC TTL (default)
 - Input Voltage (Source Type): 0~30 VDC (Digital Output)
 - Digital Output (Sink Type): 5VDC TTL (default), max current: 20mA
 - Digital Output (Source Type): 0~30VDC, max current: 250mA
- 10-Pin terminal block for 8 x DI and 8 x DO
 - Isolation: 5K Vrms (Isolated Digital Input)
 - Input Voltage (Internal Type): 5VDC TTL (default)
 - Input Voltage (Source Type): 0~30 VDC (Isolated Digital Output)
 - Digital Output (Sink Type): 5VDC TTL (default), max current: 20mA
 - Digital Output (Source Type): 0~30VDC, max current: 250mA
- 5-Pin terminal block for 3x analog input
 - Isolation: 2K Vrms
 - 2 x isolated analog voltage input 12VDC (Max.)
 - 1 x isolated analog current input 10A (Max.)
- 2 x USB 2.0 host type A connector
- 2 x RJ45 with LEDs for 10/ 100/ 1000Mbps Ethernet

Dimension Drawing



- 1 x Line-out, 1 x Mic-in
- 1 x DB9 male connector for 1 x OBDII (default) or 2 x OBDII (option)
- 1 x SMA-type GPS antenna connector
- 4 x Antenna hole reserved for SMA-type antenna connector (WWAN/ WLAN/ BT)

Power Management

- Selectable boot-up & shut-down voltage for low power protection by software
- Setting 8-level on/off delay time by software
- Status of ignition and low voltage status can be detected by software
- Support S3/ S4 suspend mode

Operating System

- Windows XP/ WES2009
- WES 7E
- Win7 Pro for Embedded
- Linux 2.6

Dimensions

- 260mm (W) x 176mm (D) x 90.1mm (H) (10.24" x 6.93" x 3.51")
- 3.89 Kg (8.57 Lb)

Construction

- Aluminum enclosure with fanless design

Environment

- Operating temperatures:
Ambient with air: -30°C to 50°C
- Storage temperatures: -35°C to 85°C
- Relative humidity: 10% to 90% (non-condensing)
- Vibration (random): 1g@5~500 Hz (in operation, SSD)
- Vibration (SSD):
Operating: MIL-STD-810G, Method 514.6, Category 4, common carrier US highway truck vibration exposure
Storage: MIL-STD-810G, Method 514.6, Category 24, minimum integrity test
- Shock (SSD):
Operating: MIL-STD-810G, Method 516.6, Procedure I, functional shock=20g

Non-Operating: MIL-STD-810G, Method 516.6, Procedure V, crash hazard shock test=75g

Standards/ Certifications

- CE approval
- FCC Class A
- e13 Mark

Ordering Information

• VTC 7110-D1K (P/N: 10V00711007X0)

Intel® Core™ i7 1.5GHz, 2GB DDR3 SODIMM, LVDS/ VGA Output, 1 x RS-232, 1 x RS-485/422 with isolation DI/DO, COM and 1 x OBDII (SAEJ1939 or J1708)

• Optional Accessories

Part No.	Description
10VD0100000X0	VMD 1000-B 7" monitor w/ touch screen
10VD0100101X0	VMD 1001-B 7" Monitor w/ touch screen, VGA interface
10VD0200000X0	VMD 2000-B 8" Monitor w/ touch screen
10VD0200200X0	VMD 2002-B 8" Monitor w/ touch screen, cable integration
10VK0071F00X0	VTK 71F, fan kit
10VK0006013X0	Wireless mini card kit, Ralink 802.11b/g/n 2T2R, QCOM: Q802XKN5F, w/ antenna & cable (without assembly in NEXCOM)
10VK0WWAN01X0	Cinterion PHS8-P kit, Five bands, UMTS/HSPA (850/800, 900, 1900 and 2100 MHz), Quad-Band GSM w/ internal cable, antenna & packing (without assembly in NEXCOM)
10VK00GPS00X0	SKYTRAQ GPS + GLONASS, w/ antenna & cable
10VK0006007X0	Bluetooth kit, QCOM: QBTM400-01(V7), w/ antenna & cable (without assembly in NEXCOM)
7400120002X00	Power adapter FSP: 120-AAB (N09001), 120W 19V/ 6.3A
60233SAM03X00	Internal cable for GSM/ WLAN/ GPS antenna connection MOQ: 20 pcs
60233SAM05X00	GPS antenna/ 5m/ SMA180P
60233SAM07X00	GSM/ GPRS antenna, SMA, support 850, 900, 1800, 1900
60233SMA30X00	GPS+GSM combo antenna 5M/ SMA180P
60233SAM17X00	GPRS/ UMTS/ HSDPA antenna, SMA, support 850, 900, 1800, 1900 and 2100 MHz
60233SAM07X00	GSM/ GPRS antenna, SMA, support 850, 900, 1800, 1900
60233SMA30X00	GPS+GSM combo antenna 5M/ SMA180P
60233SAM17X00	GPRS/ UMTS/ HSDPA antenna, SMA, support 850, 900, 1800, 1900 and 2100 MHz